Features

- Frequency range : 20MHz to 66MHz
- Ultra compact and thin
- AuSn sealing, ceramic SMD package
- External dimensions (mm)
  L : 1.6 x W : 1.2 x H : 0.35
- RoHS compliant & Pb free

Applications

- BT, BLE, W-LAN, NFC
- SiP modules
- Mobile phone, Wearables
- Internet of Things (IoT)
- Portable consumer products

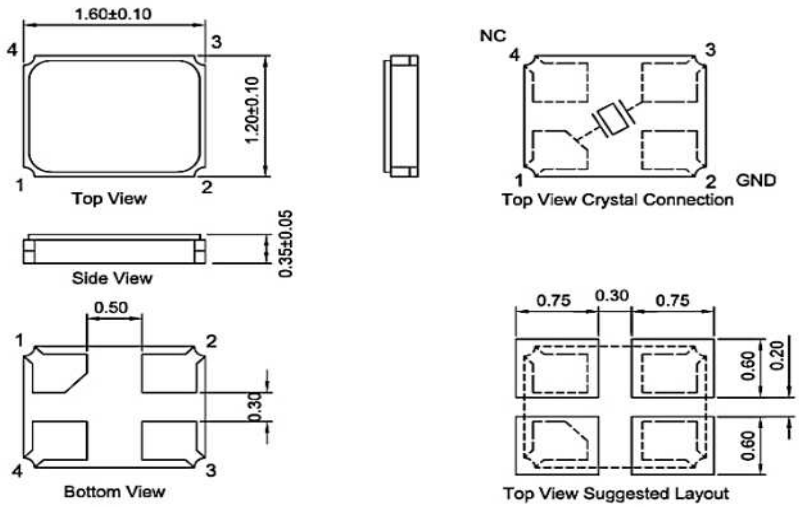
Electrical Characteristics

Item		8Q	Conditions
Frequency Range	F_0	20MHz ~ 66MHz	
Frequency Tolerance	F_{tol}	±30ppm, ±20ppm, ±10ppm	at 25°C
Frequency Stability over Operating Temperature Range (refer to 25°C)	F_{stab}	±30 ppm	-20°C ~ +70°C
		±20 ppm	
		±10 ppm	
		±10 ppm	-30°C ~ +85°C
		±30 ppm	-40°C ~ +85°C
		±20 ppm	
		±60 ppm	-40°C ~ +125°C
Operating Temperature Range	T_{OTR}	-20°C ~ +70°C	
		-40°C ~ +85°C	
		-40°C ~ +125°C	
Shunt Capacitance	C_0	3pF Max.	
Drive Level	D_L	1 ~ 200μW (50μW Typ.)	
Load Capacitance	C_L	6pF, 7pF, 8pF, 9pF, 10pF, 12pF, 16pF, 18pF	
Aging	F_{aging}	±3 ppm Max.	at 25°C ± 3°C,first year
Storage Temperature Range	T_{STR}	-55°C ~ +125°C	

Motional Resistance (ESR)

Fundamental	
20 ~ 30 MHz	100Ω Max.
30 ~ 66 MHz	80Ω Max.

Dimensions



(Unit: mm)

Ordering Information

8Q - 27.000M A H E - T

Frequency in Hz

Please contact us for available frequencies

Packaging Method

T	Tape & Reel

Frequency Tolerance (at 25℃)

A	±30 ppm
D	±20 ppm
E	±10 ppm

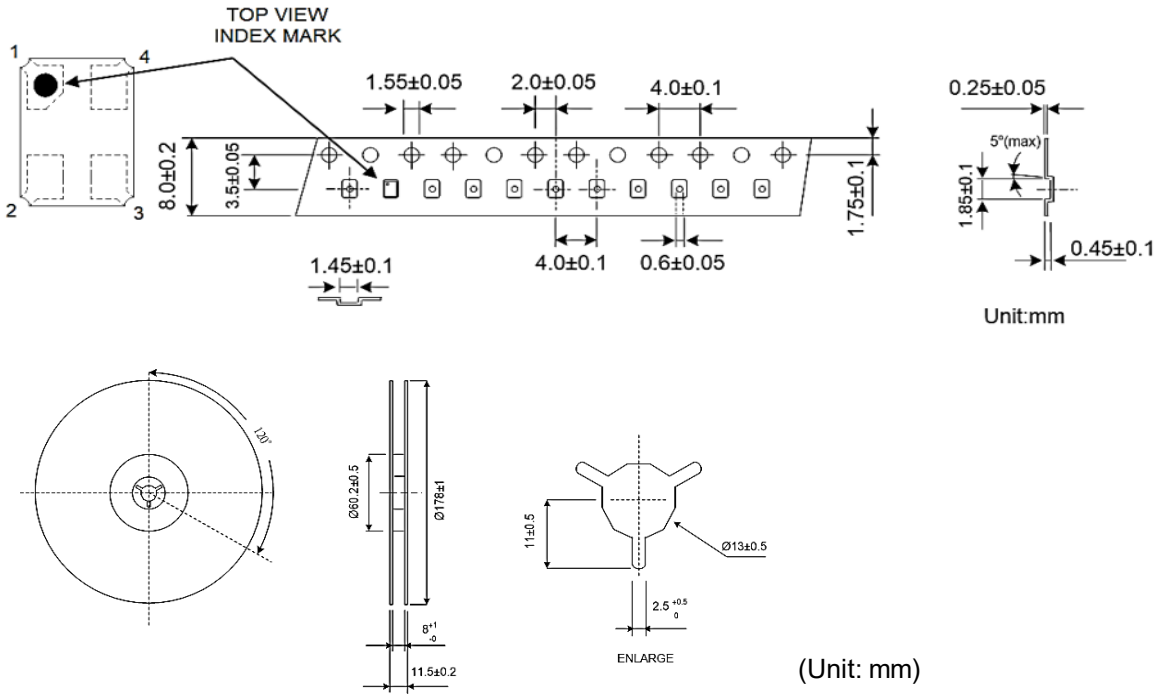
Load Capacitance

B	6 pF
Y	7 pF
V	8 pF
C	9 pF
Q	10 pF
E	12 pF
I	16 pF
J	18 pF

Frequency Stability (over Temp.)

A	±30 ppm	(-20℃ ~ +70℃)
D	±20 ppm	(-20℃ ~ +70℃)
E	±10 ppm	(-20℃ ~ +70℃)
T	±10 ppm	(-30℃ ~ +85℃)
H	±30 ppm	(-40℃ ~ +85℃)
I	±20 ppm	(-40℃ ~ +85℃)
K	±60 ppm	(-40℃ ~ +125℃)

Packing



(Unit: mm)

Reflow Profile

Solder melting point : 220℃ ± 10℃, 60 sec. Min.
Peak temperature : 260℃ ± 10℃, 10 sec. Min.

